



Description

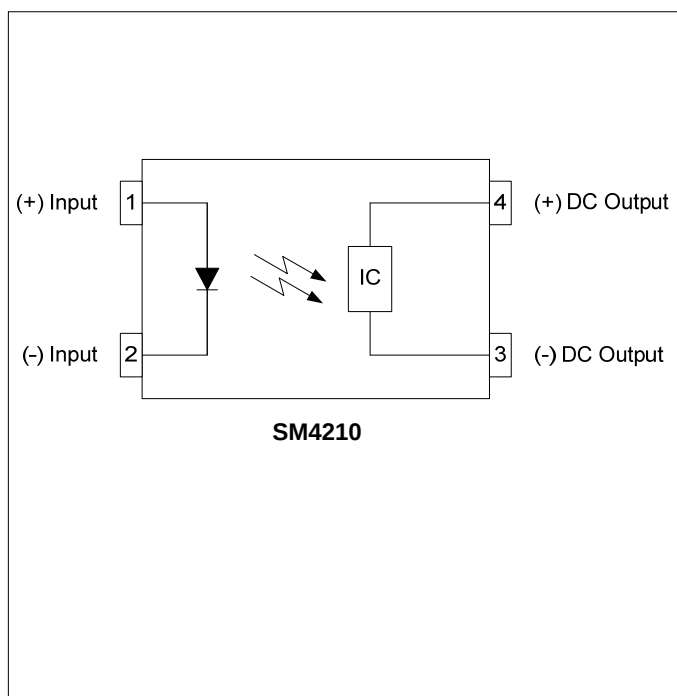
The SM4210 consists of an input drive LED optically coupled to a photodiode array output designed to drive highly capacitive loads, including the gate of a power MOSFET. The active discharge circuit of the PDA assures quick discharge of MOSFETs, providing fast turn-off times. This device can be used in a wide variety of applications for which high levels of input are required for a MOSFET output.

The SM4210 comes standard in a miniature 4 pin SOP package.

Applications

- Isolated means to drive discrete power MOSFETs
- Lighting Controls
- Process Control Modules
- Solid State Relays
- Solenoid Controls

Schematic Diagram



Features

- Miniature 4 pin SOP package
- Built in active discharge circuit for fast turn-off
- Fast Turn-On
- 12V Gate Drive Voltage
- High Input-to-Output Isolation (1.5kV_{RMS})
- Long Life / High Reliability
- RoHS / Pb-Free / REACH Compliant

Agency Approvals

UL / C-UL: File # E201932
 VDE: File # 40035191 (EN 60747-5-2)

Absolute Maximum Ratings

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

Storage Temperature-55 to +125°C
 Operating Temperature-40 to +85°C
 Continuous Input Current.....50mA
 Transient Input Current.....500mA
 Reverse Input Control Voltage5V
 Input Power Dissipation.....70mW
 Total Power Dissipation170mW
 Solder Temperature – Wave (10sec).....260°C
 Solder Temperature – IR Reflow (10sec).....260°C

Ordering Information

Part Number	Description
SM4210	4 pin SOP, (100/Tube)
SM4210-TR	4 pin SOP, Tape and Reel (2000/Reel)

NOTES: Suffixes listed above are not included in marking on device for part number identification

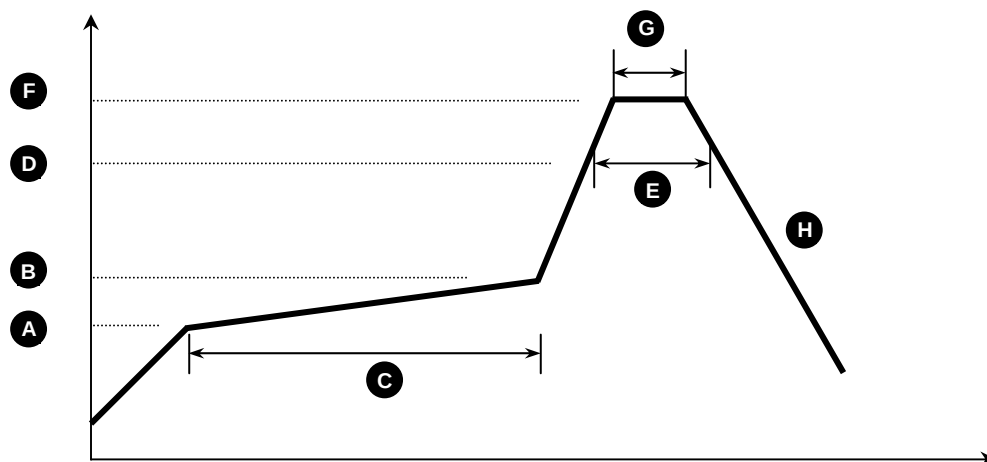
Electrical Characteristics, $T_A = 25^\circ\text{C}$ (unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Input Specifications						
LED Forward Voltage	V_F	-	2.8	3.5	V	$I_F = 10\text{mA}$
LED Reverse Voltage	BV_R	5	-	-	V	$I_R = 10\mu\text{A}$
Reverse Leakage Current	I_{InRleak}	-	-	10	μA	$V_R = 5\text{V}$
Turn-On Current	I_F	-	5	10	mA	$V_{\text{OUT}} = 5\text{V}$
Turn-Off Current	$I_{F(\text{OFF})}$	-	0.5	-	mA	$V_{\text{OUT}} = 2\text{V}$
Output Specifications						
Open Circuit Voltage	V_{OC}	12	14	-	V	$I_F = 10\text{mA}$
Short Circuit Voltage	I_{SC}	20	25	-	μA	$I_F = 10\text{mA}$
Isolation Specifications						
Isolation Voltage	V_{ISO}	1500	-	-	V_{RMS}	$\text{RH} \leq 50\%, t=1\text{min}$
Input-Output Resistance	$R_{\text{I-O}}$	-	10^{12}	-	Ω	$V_{\text{I-O}} = 500\text{V}_{\text{DC}}$

SM4210 Solder Reflow Temperature Profile Recommendations

(1) Infrared Reflow:

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250°C:



Process Step	Description	Parameter
A	Preheat Start Temperature (°C)	150°C
B	Preheat Finish Temperature (°C)	180°C
C	Preheat Time (s)	90 - 120s
D	Melting Temperature (°C)	230°C
E	Time above Melting Temperature (s)	30s
F	Peak Temperature, at Terminal (°C)	260°C
G	Dwell Time at Peak Temperature (s)	10s
H	Cool-down (°C/s)	<6°C/s

(2) Wave Solder:

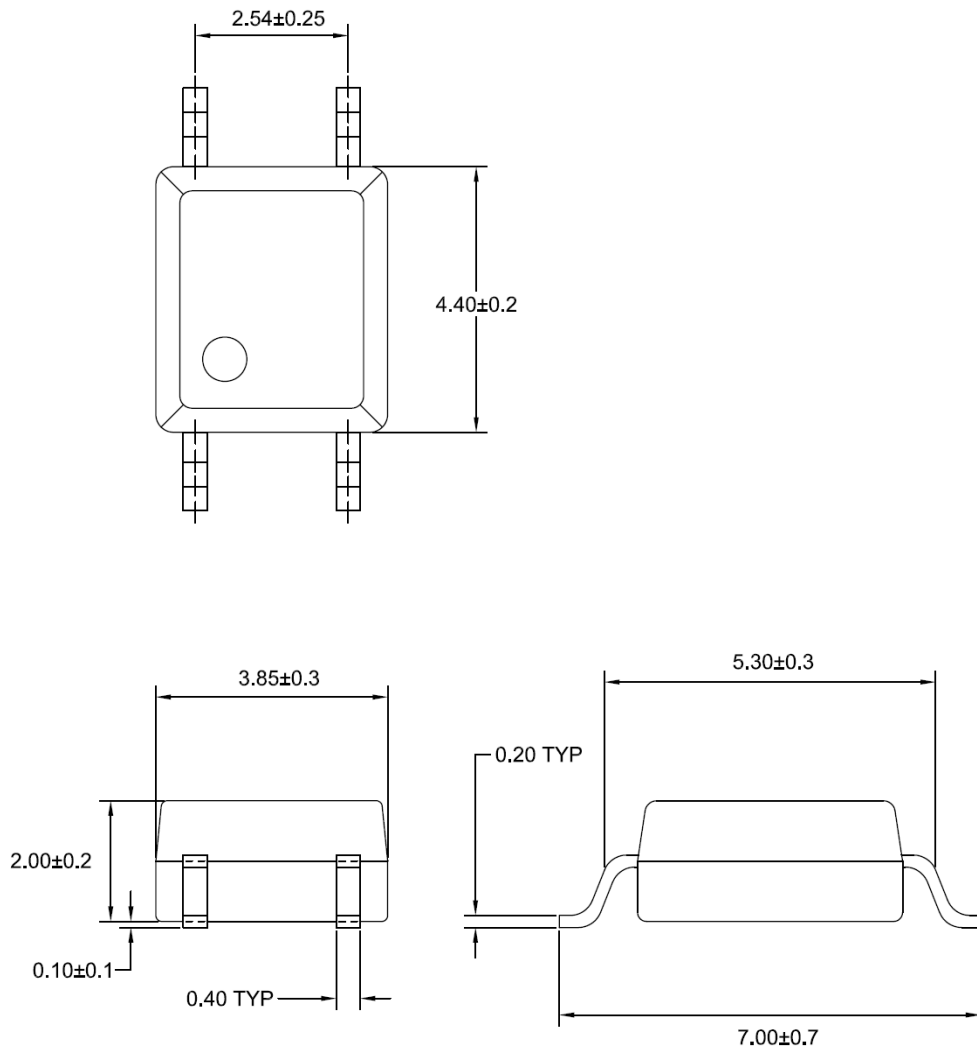
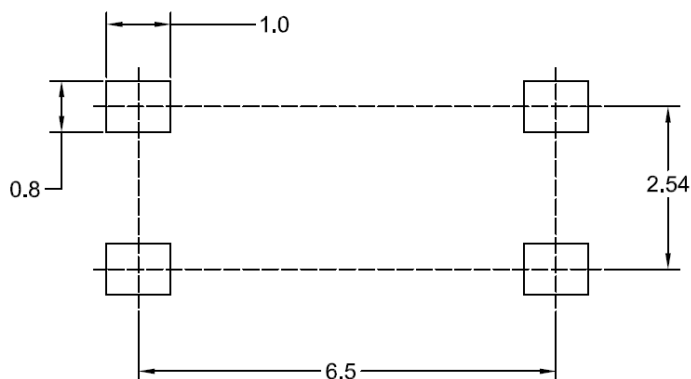
Maximum Temperature: 260°C (at terminal)
 Maximum Time: 10s
 Pre-heating: 100 - 150°C (30 - 90s)
 Single Occurrence

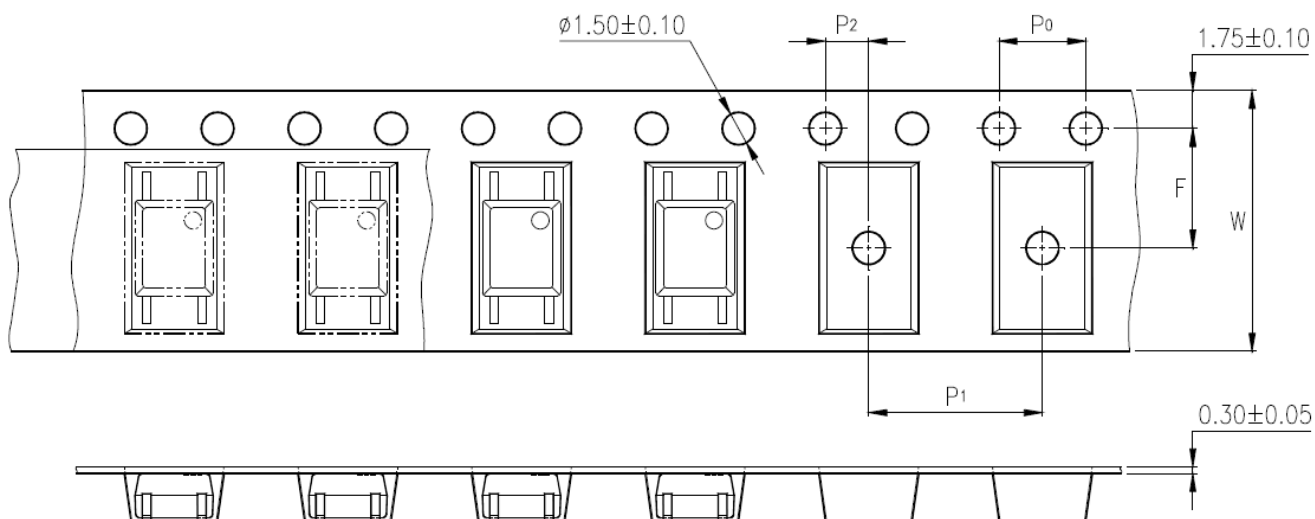
(3) Hand Solder:

Maximum Temperature: 350°C (at tip of soldering iron)
 Maximum Time: 3s
 Single Occurrence

SM4210 Package Dimensions
4 PIN SOP Package

Note: All dimensions in millimeters [mm]


4 PIN SOP Footprint


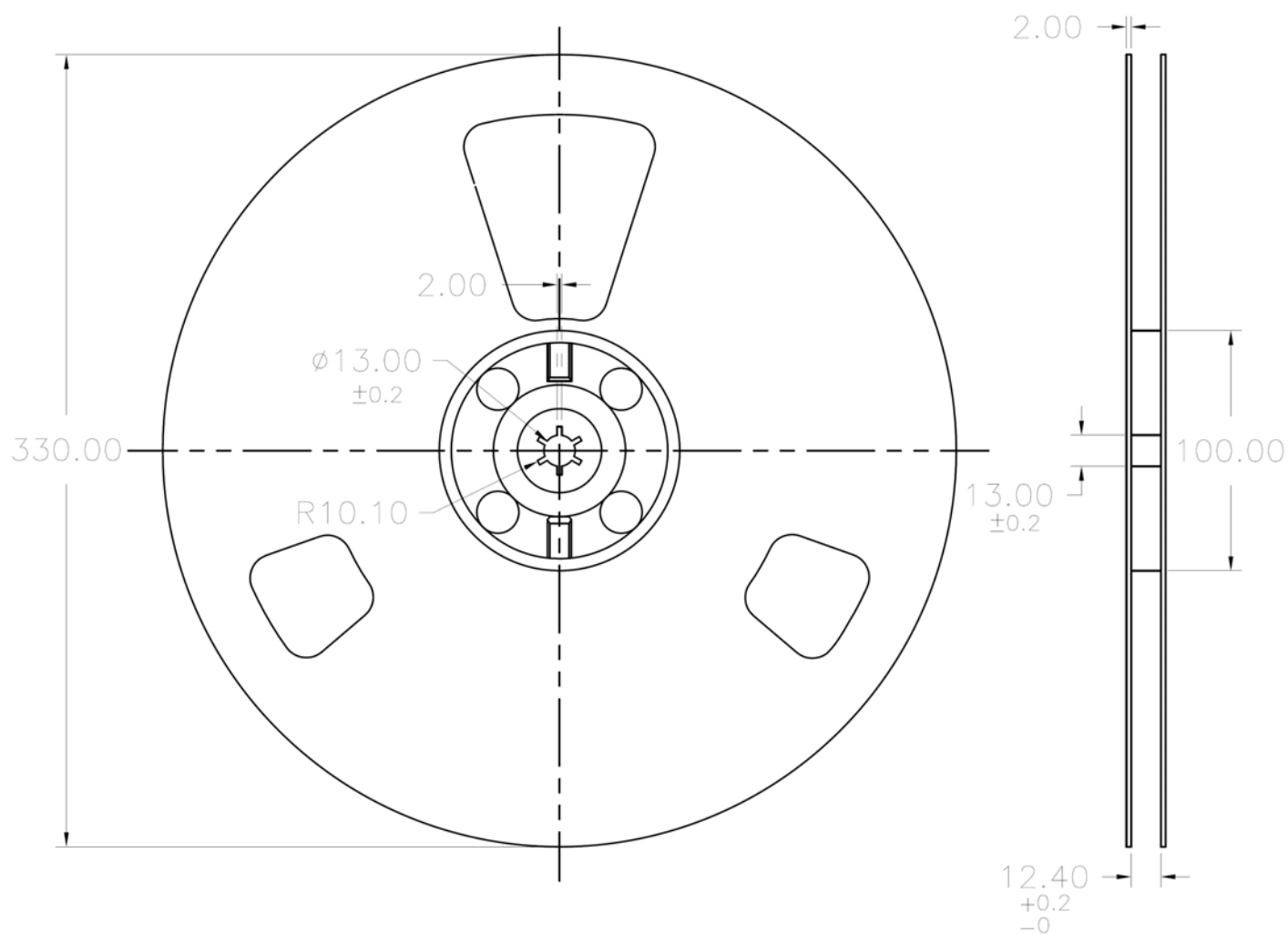
SM4210 Packaging Specifications
Tape & Reel Specifications (T&R)
Note: All dimensions in millimeters [mm]


Specification	Symbol	Dimensions, mm (inches)
Tape Width	W	12 ± 0.3 (0.47)
Sprocket Hole Pitch	P0	4 ± 0.1 (0.15)
Compartment Location	F P2	5.5 ± 0.1 (0.217) 2 ± 0.1 (0.079)
Compartment Pitch	P1	8 ± 0.1 (0.315)

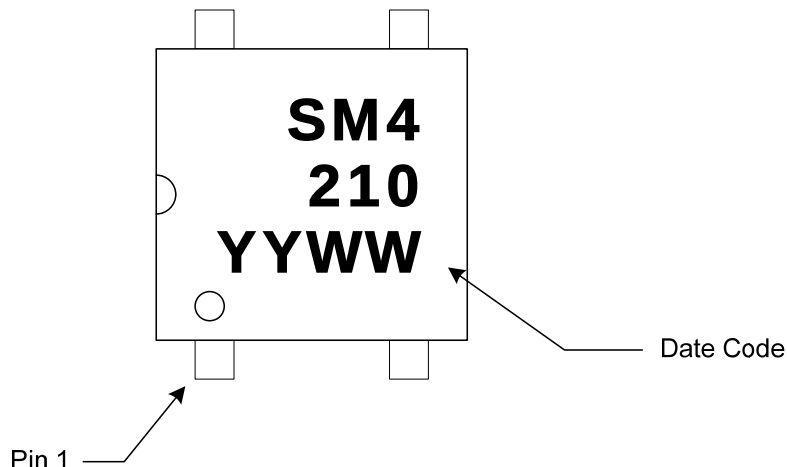
SM4210 Packaging Specifications

Tape & Reel Specifications (T&R)

Note: All dimensions in millimeters [mm]



SM4210 Package Marking



SM4210 Package Weights

Device	Single Unit	Full Tube (100pcs)	Full Pouch (10 tubes)	Full Reel (2000pcs)
SM4210	0.10	23	240	-
SM4210-TR	0.10	-	-	500

Note: All weights above are in GRAMS, and include packaging materials where applicable

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